

# INKE211AC1

Built-in Zener Diode  
MOS field-effect transistor  
Silicon N-channel

## DESCRIPTION

INKE211AC1 is a silicon N-channel MOS transistors with built-in Zener diode between drain and source, and small package (SC-59).

## FEATURE

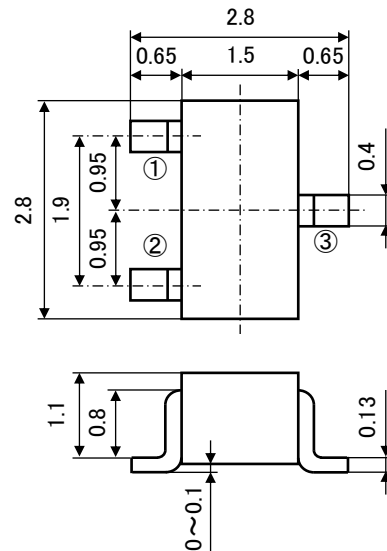
- Low on Resistance.  
 $R_{DS(ON)}=250\text{m}\Omega\text{ (TYP)}$  @ $I_D=500\text{mA}$ ,  $V_{GS}=4.5\text{V}$   
 $R_{DS(ON)}=200\text{m}\Omega\text{ (TYP)}$  @ $I_D=500\text{mA}$ ,  $V_{GS}=10\text{V}$
- High speed switching.
- Drive voltage 4V
- Built-in Zener diode between drain and source.
- Large avalanche resistance.
- Small package for High-density packaging.

## APPLICATION

Motor drive, High-speed switching  
Analog switching, and others.

## OUTLINE DRAWING

UNIT : mm



TERMINAL CONNECTER

- ① : GATE
- ② : SOURCE
- ③ : DRAIN

JEITA : SC-59

JEDEC : Similar to TO-236

## MAXIMUM RATINGS ( $T_a=25^\circ\text{C}$ )

Symbol	Parameter	Rating	Unit
$V_{GS}$	Gate-Source Voltage	$\pm 20$	V
$I_D$	Drain Current(DC)	1	A
$I_{DP}$	Drain Current(Pulse) ※1	2	A
PD	Total Power Dissipation	200	mW
		550 (※2)	mW
$I_{AV}$	Avalanche Current ※3,4	1.0	A
EAV	Avalanche Energy ※3,4	0.06	mJ
$T_{ch}$	Channel Temperature	+150	$^\circ\text{C}$
$T_{stg}$	Storage Temperature	-55~+150	$^\circ\text{C}$

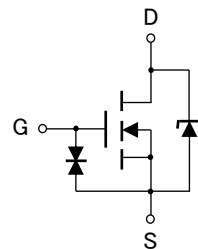
※1 :  $P_W \leq 1\text{ms}$ , Duty  $\leq 1\%$

※2 : Package mounted on glass-epoxy substrate (20mm × 20mm × 1mm, Cu pad 100mm<sup>2</sup>)

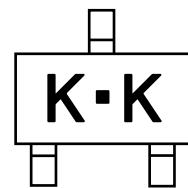
※3 : Consecutive pulses  $P_W \leq 20\ \mu\text{s}$ , Duty  $\leq 0.2\%$

※4 :  $L=100\ \mu\text{H}$

## EQUIVALENT CIRCUIT



## MARKING



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## 【MOSFET】 ELECTRICAL CHARACTERISTICS (Ta=25°C)

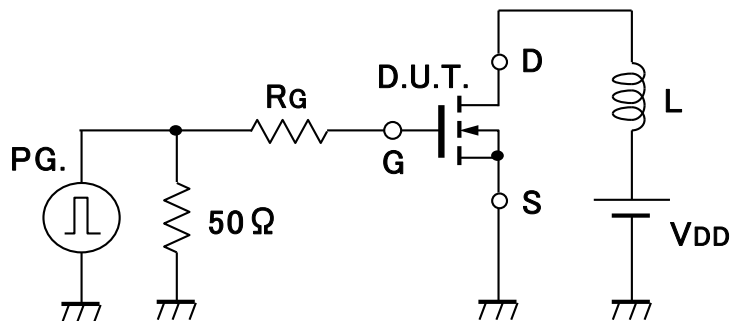
Symbol	Parameter	Test Condition	Limit			Unit
			MIN.	TYP.	MAX.	
V(BR)DSS	Drain-Source Breakdown Voltage	Id=100μA, VGS=0V	40	-	60	V
IGSS	Gate-Source Leak current	VGS=±20V, VDS=0V	-	-	±10	μA
IDSS	Zero Gate Voltage Drain Current	VDS=40V, VGS=0V	-	-	1	μA
Vth	Gate Threshold Voltage	Id=250μA, VDS=VGS	1.0	-	2.0	V
Yfs	Forward Transfer Admittance	VDS=10V, Id=500mA	-	1.5	-	S
RDS(ON)	Static Drain-Source On-State Resistance	Id=500mA, VGS=4.5V	-	250	-	mΩ
		Id=500mA, VGS=10V	-	200	-	
Ciss	Input Capacitance	VDS=5V, VGS=0V, f=1MHz	-	170	-	pF
Coss	Output Capacitance		-	40	-	
ton	Switching Time	VDD=5V, Id=250mA VGS=0~5V	-	170	-	ns
toff			-	85	-	

## 【Zener Diode】 ELECTRICAL CHARACTERISTICS (Ta=25°C)

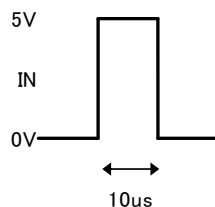
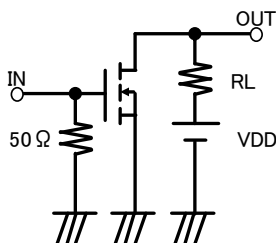
Zener Voltage Vz(V)			Reverse current IR (μA)	
MIN	MAX	Iz(mA)	MAX	VR(V)
40	60	0.1	1.0	40

### Avalanche current test condition

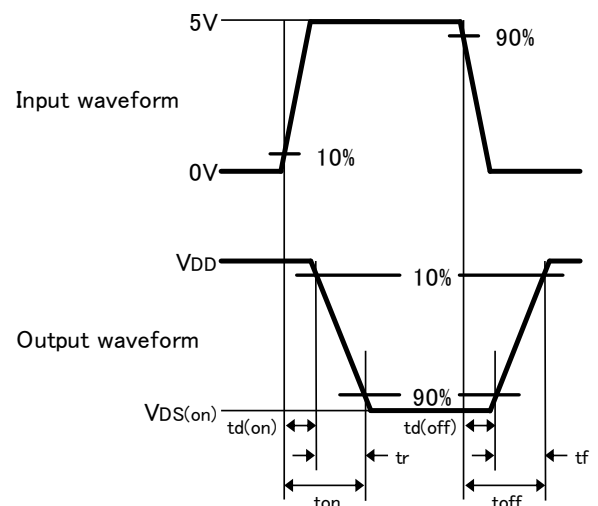
Ta=25°C  
RG=25Ω  
VDD=20V  
VGS=10→0V



### Switching time test condition



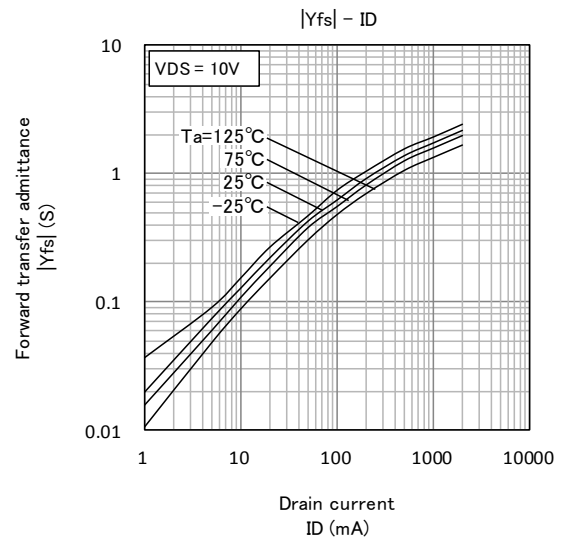
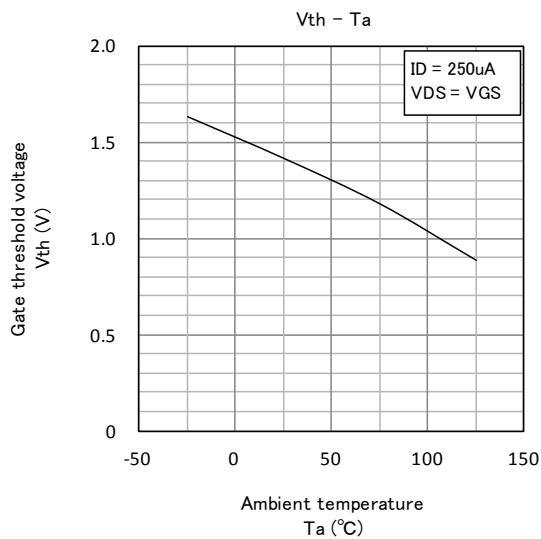
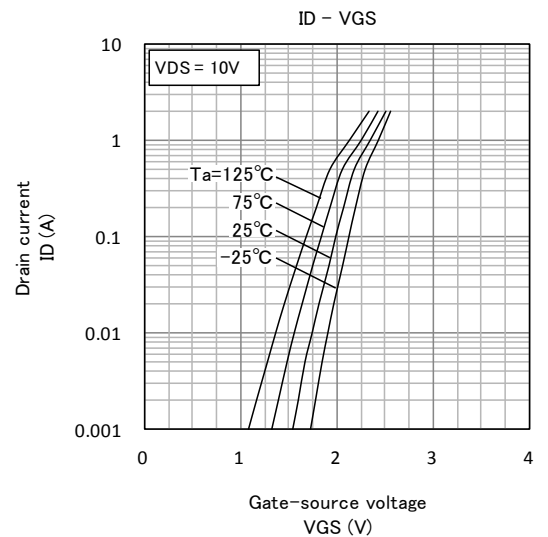
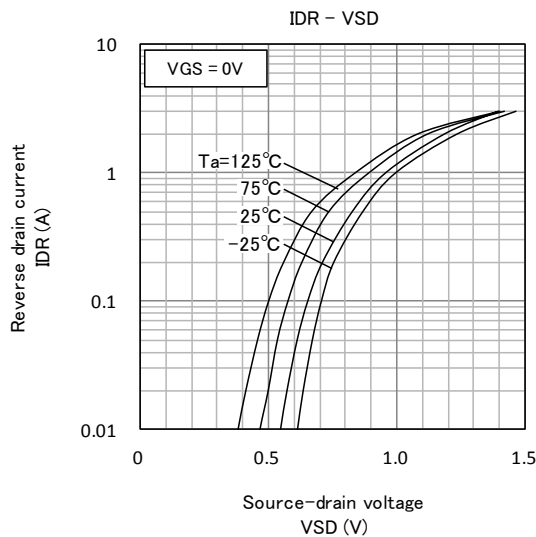
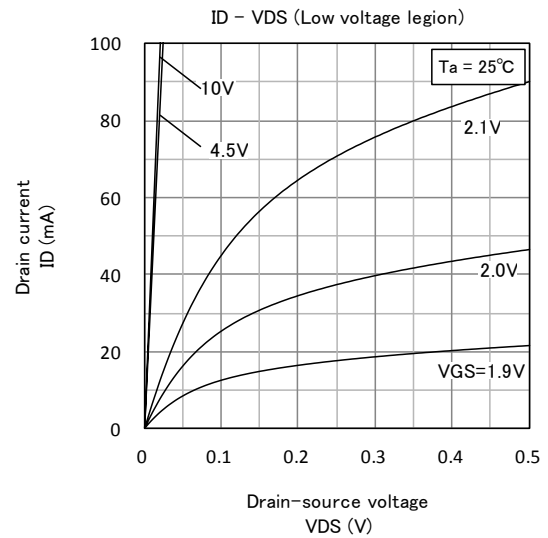
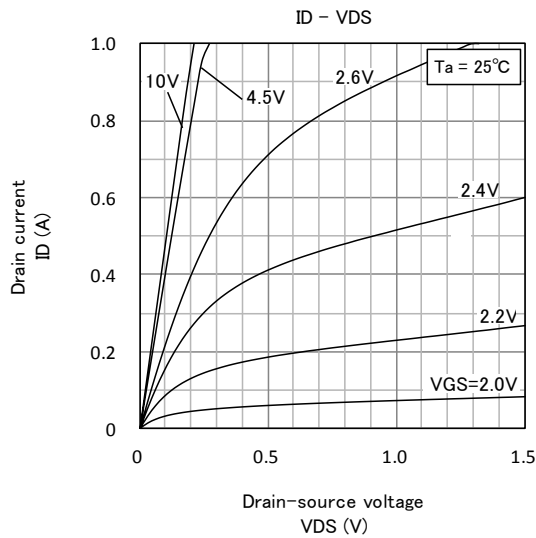
Duty ≤ 1%  
Input: tr, tf < 10ns  
VDD = 5V  
Common source  
Ta = 25°C



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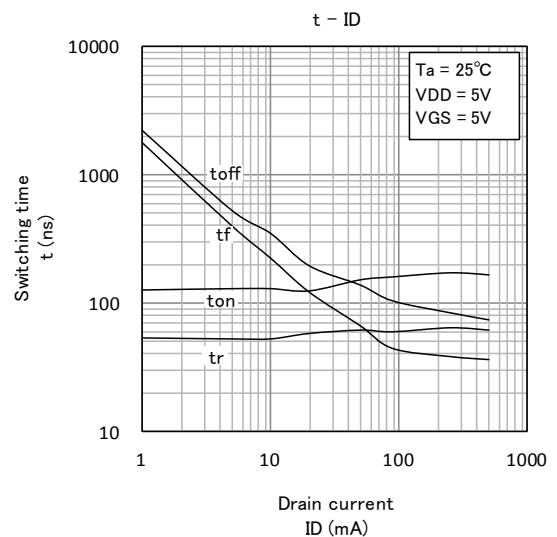
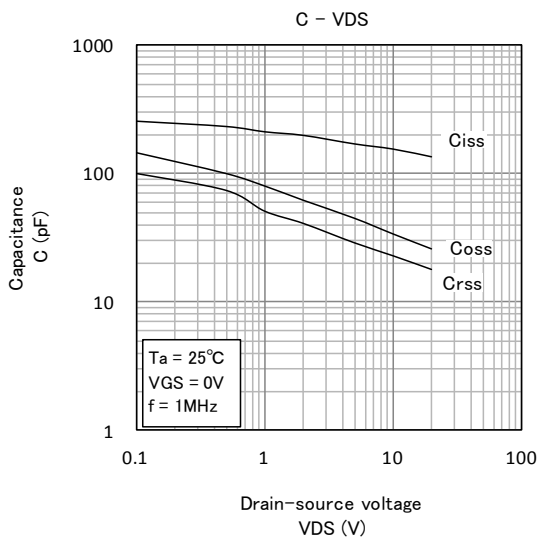
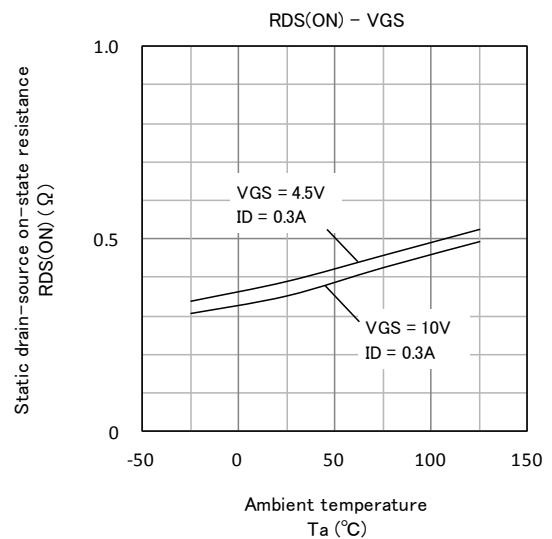
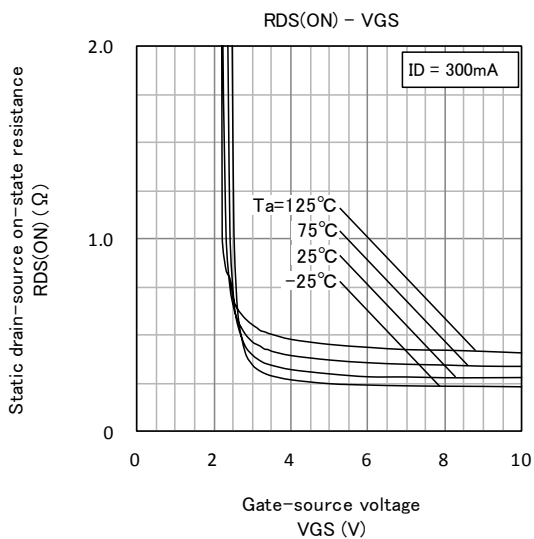
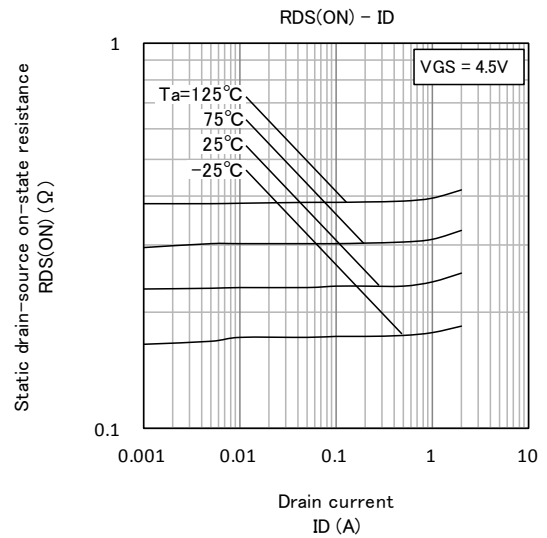
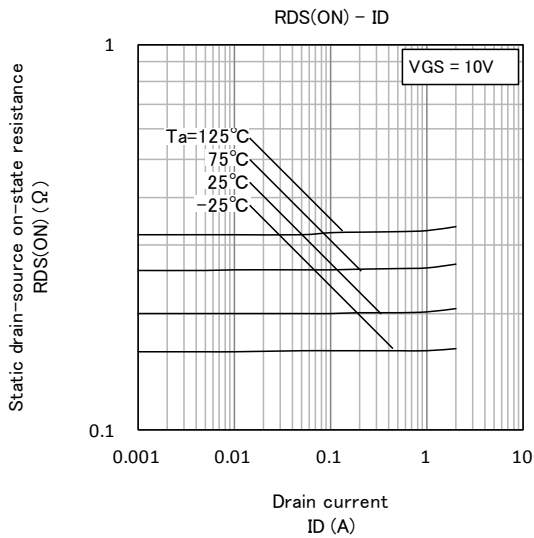
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## TYPICAL CHARACTERISTICS



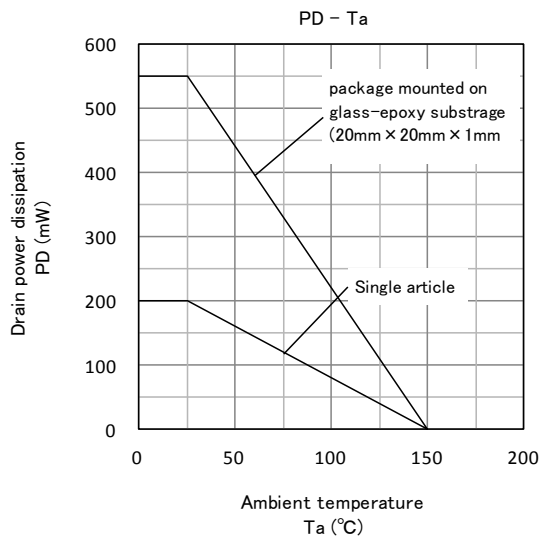
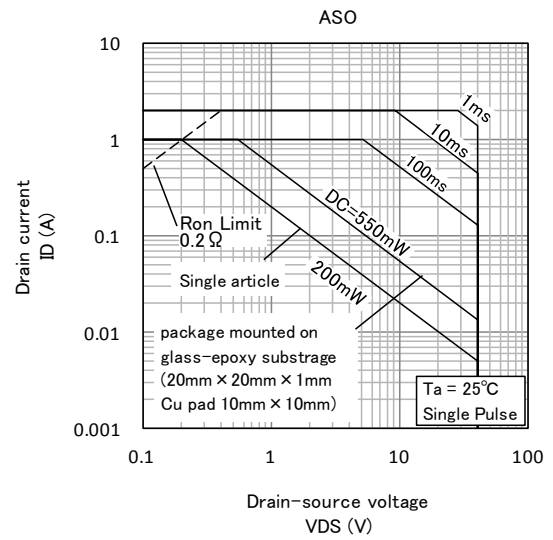
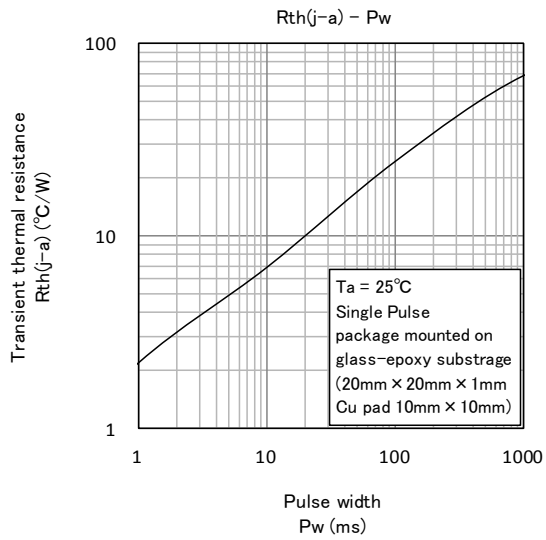
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